

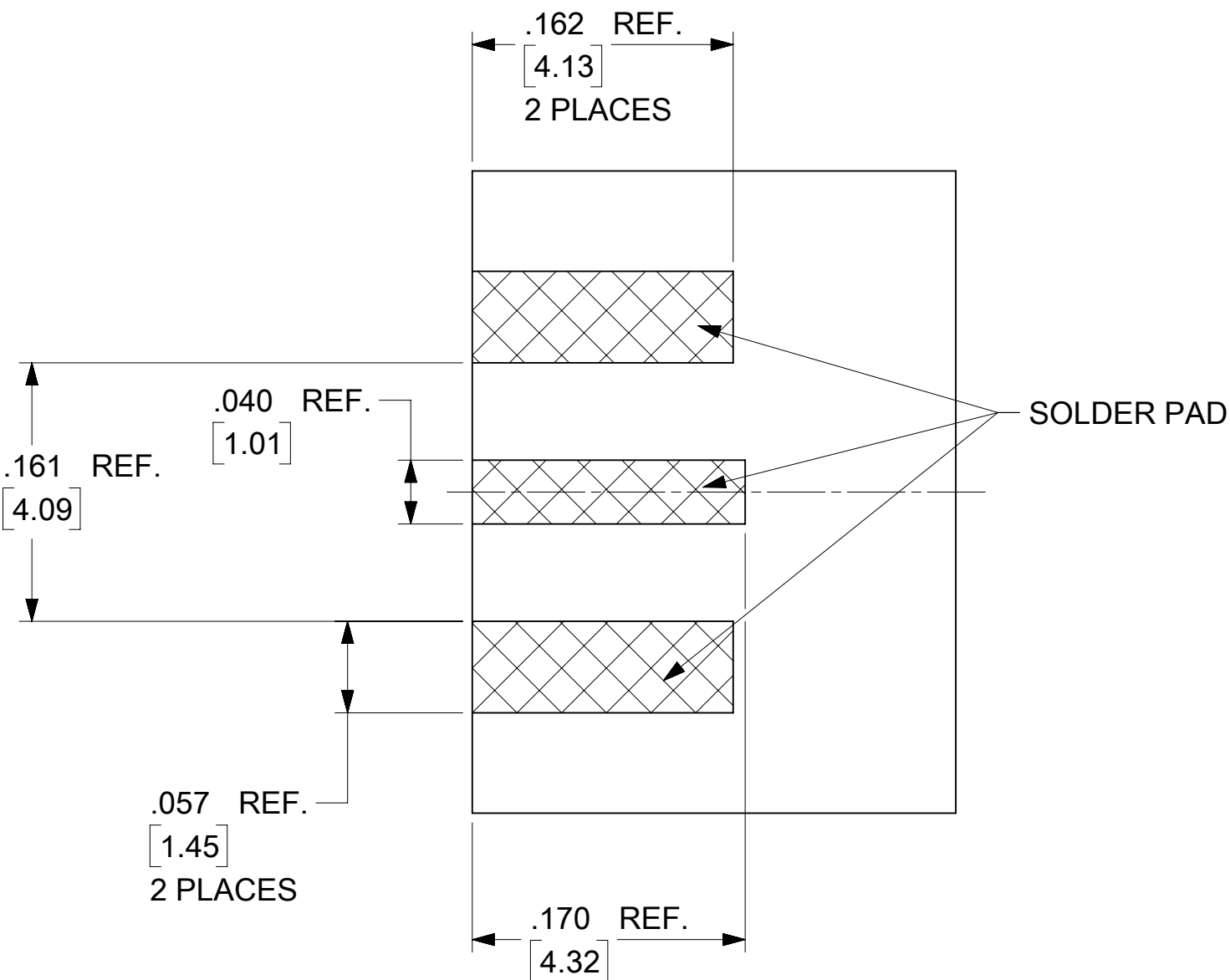
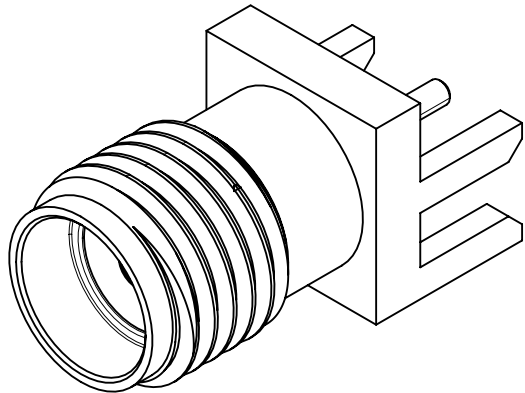
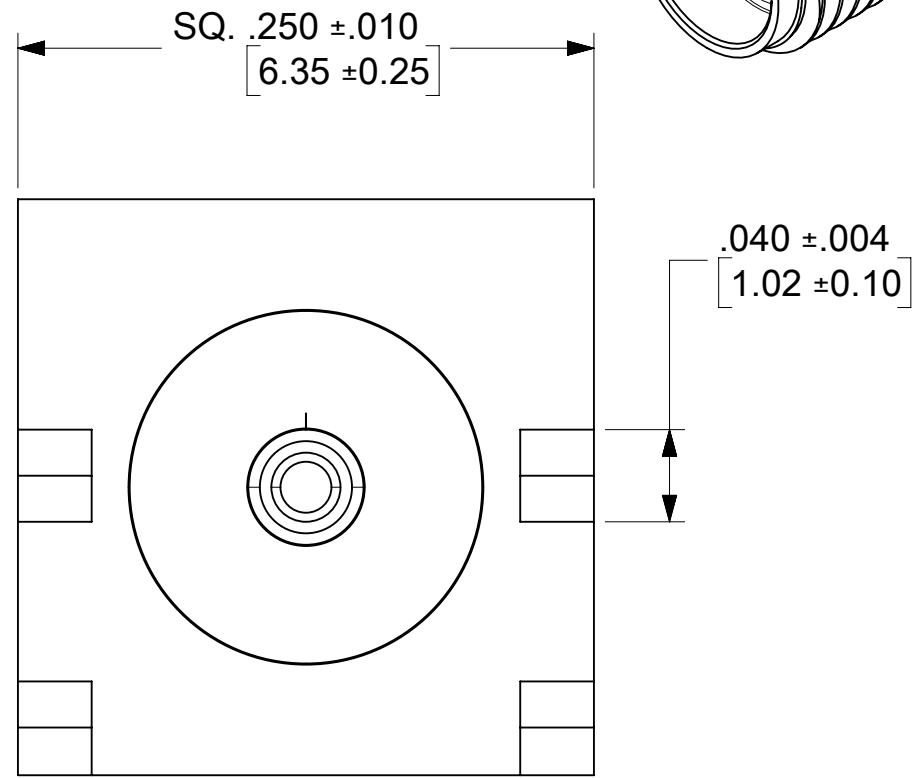
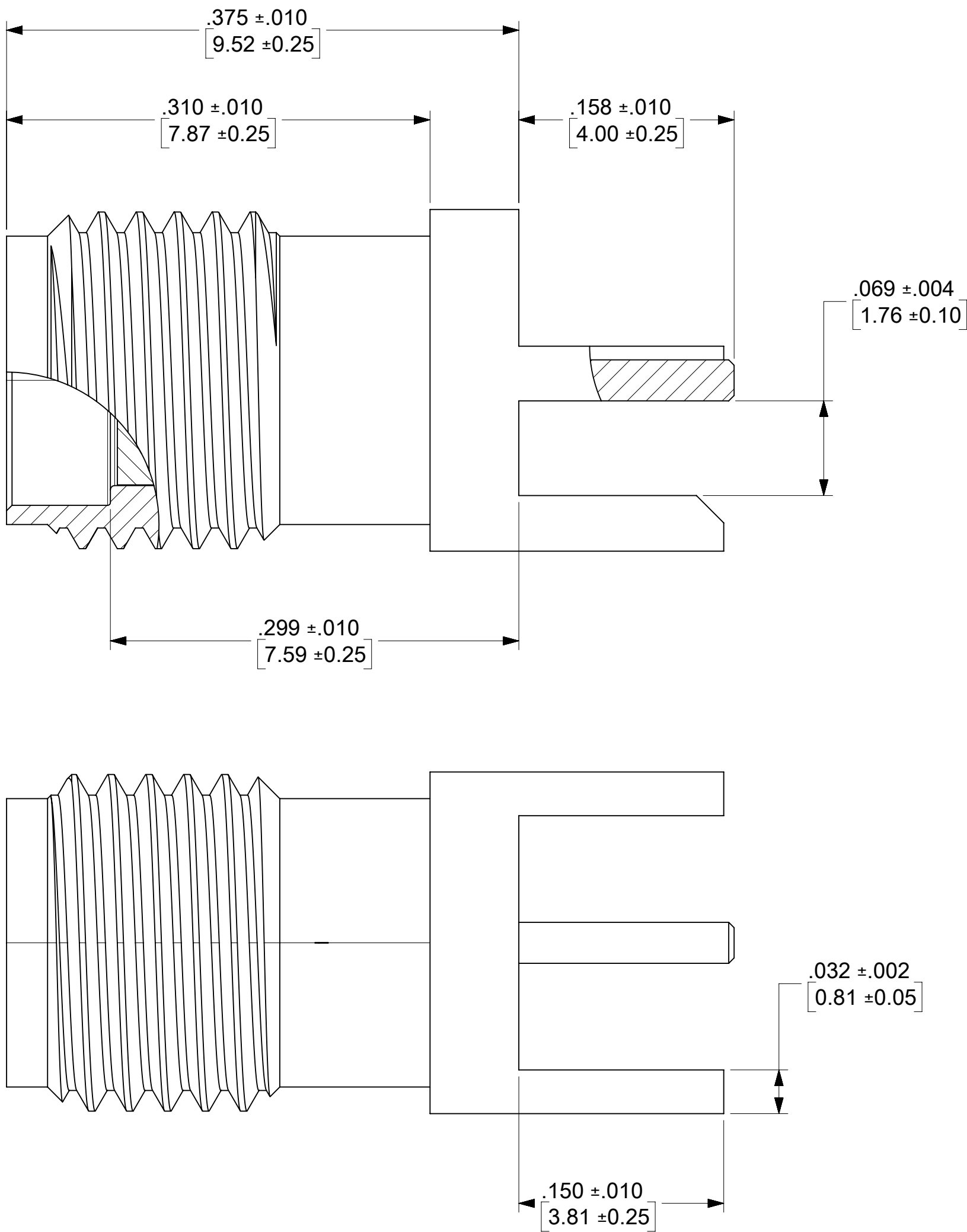
MATERIALS AND FINISHES

BODY: BRASS
PLATED SEE TABLE

CENTER CONTACT: BERYLLIUM COPPER
PLATED GOLD

INSULATOR: TEFLON

PACKAGE BY TRAY
(PACKAGE SPECIFICATION 89542-0040)



SOLDER PAD

RECOMMENDED PCB LAYOUT

PS-89675-3460	PRODUCT SPECIFICATION
MIL-STD-348A, FIG. 310-2	INTERFACE SMA JACK
SPECIFICATION	DESCRIPTION

73251-5461	NICKEL
73251-5460	GOLD
PART NO.	BODY

DOCUMENT STATUS	P1	RELEASE DATE	2022/03/09	08:08:44
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FUNCTIONAL SYMBOLS F A = 0 F C = 0 F P = 0 DIVISIONAL SYMBOLS	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION									
	DIMENSION UNITS		SCALE		CURRENT REV DESC: NEW PRODUCT PER EWR # 15054-A/PDR1007605			molex		
	INCH/MM		NTS							
	GENERAL TOLERANCES (UNLESS SPECIFIED)									
	ANGULAR TOL ± °				EC NO: 698213 DRWN: ELIN					

molex

SMA JACK EDGE MOUNT 50 OHMS
EWR # 15054, SMA-J/PCB

PRODUCT CUSTOMER DRAWING

DOCUMENT NUMBER	DOC TYPE	DOC PART	REVISION
732515460	PSD	000	A